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April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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# 2SK2096

## Silicon N Channel MOS FET

REJ03G0997-0200

(Previous: ADE-208-1344)

Rev.2.00 Sep 07, 2005

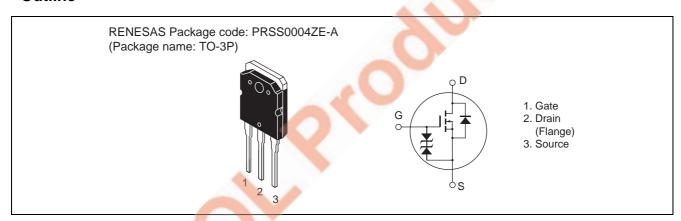
### **Application**

High speed power switching

#### **Features**

- Low on-resistance
- High speed switching
- Low drive current
- 4 V gate drive device can be driven from 5 V source
- Suitable for switching regulator, DC-DC converter
- Avalanche ratings

#### **Outline**



## **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	60	V
Gate to source voltage	$V_{GSS}$	±20	V
Drain current	I <sub>D</sub>	45	А
Drain peak current	I <sub>D(pulse)</sub> *1	180	А
Body to drain diode reverse drain current	I <sub>DR</sub>	45	А
Avalanche current	I <sub>AP</sub> *3	45	А
Avalanche energy	E <sub>AR</sub> *3	173	mJ
Channel dissipation	Pch*2	100	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1 %

2. Value at Tc = 25°C

3. Value at Tch = 25°C, Rg  $\geq$  50  $\Omega$ 

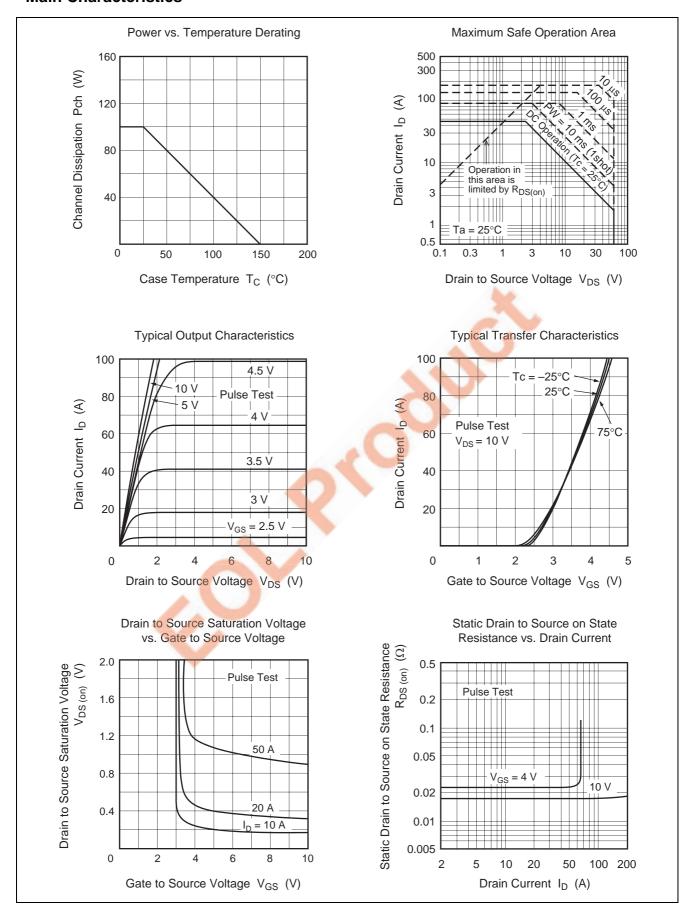
### **Electrical Characteristics**

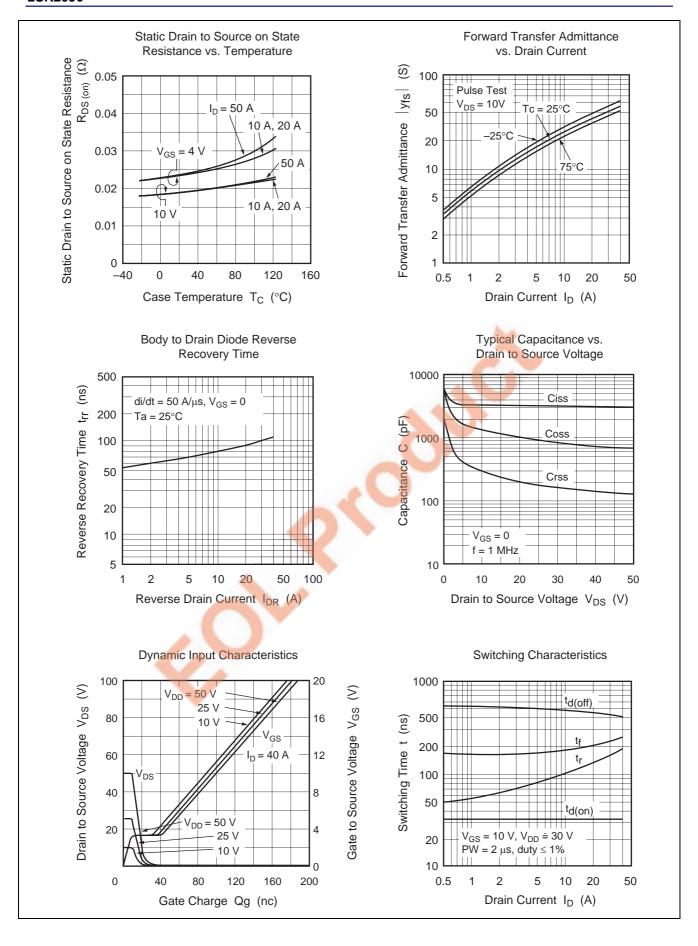
 $(Ta = 25^{\circ}C)$ 

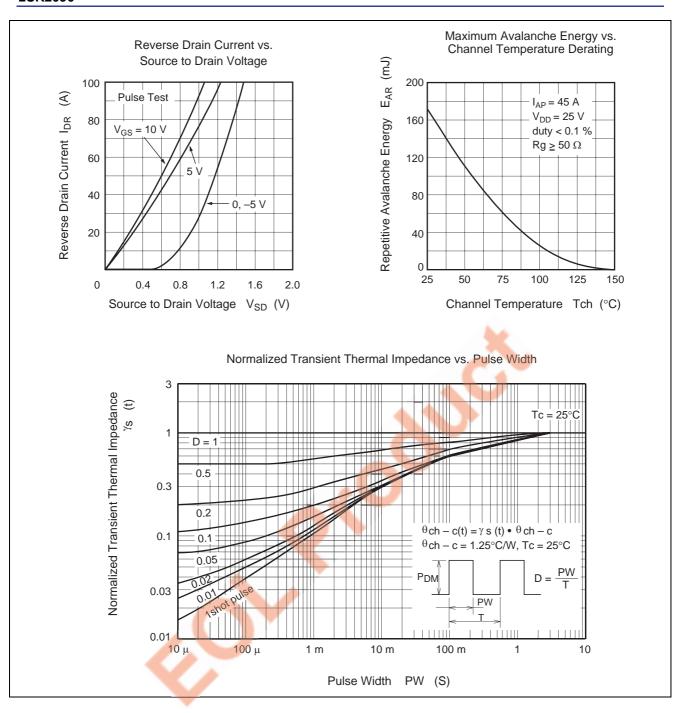
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	60	_	4	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_		V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	_	±10	μA	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	_	+	250	μΑ	$V_{DS} = 50 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	4	2.25	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state	R <sub>DS(on)</sub>	_	0.018	0.022	Ω	$I_D = 25 \text{ A}, V_{GS} = 10 \text{ V}^{*4}$
resistance			0.023	0.028	Ω	$I_D = 25 \text{ A}, V_{GS} = 4 \text{ V}^{*4}$
Forward transfer admittance	y <sub>fs</sub>	25	37	_	S	$I_D = 25 \text{ A}, V_{DS} = 10 \text{ V}^{*4}$
Input capacitance	Ciss	-	3530	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance	Coss		1480	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss	<u> </u>	300	_	pF	
Turn-on delay time	t <sub>d(on)</sub>	_	33	_	ns	I <sub>D</sub> = 25 A, V <sub>GS</sub> = 10 V,
Rise time	t	_	160	_	ns	$R_L = 1.5 \Omega$
Turn-off delay time	t <sub>d(off)</sub>	_	450	_	ns	
Fall time	t <sub>f</sub>	_	230	_	ns	
Body to drain diode forward voltage	$V_{DF}$	_	1.3	_	V	I <sub>F</sub> = 45 A, V <sub>GS</sub> = 0
Body to drain diode reverse recovery	t <sub>rr</sub>	_	130	_	ns	$I_F = 45 \text{ A}, V_{GS} = 0,$
time						di <sub>F</sub> / dt = 50 A / μs

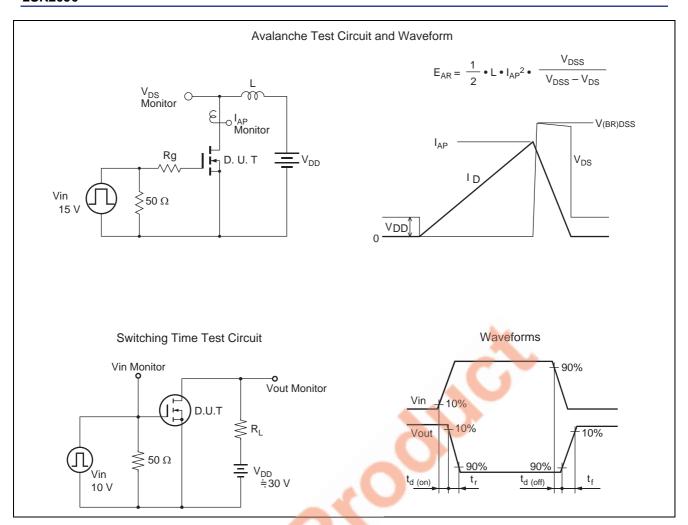
Note: 4. Pulse Test

#### **Main Characteristics**

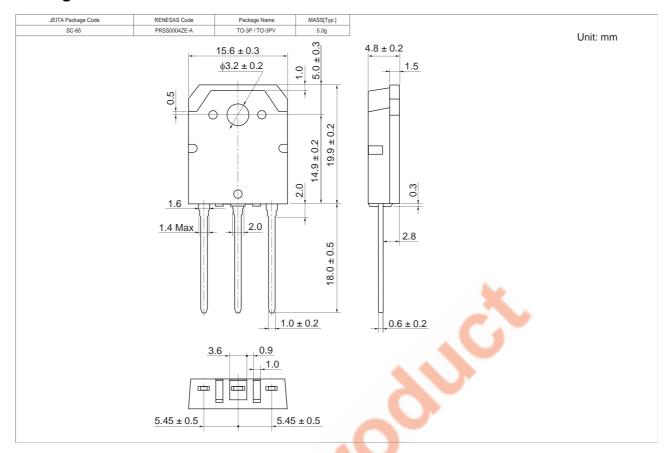








### **Package Dimensions**



### **Ordering Information**

Part Name	Quantity	Shipping Container
2SK2096-E	30 pcs	Plastic magazine

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